

Datasheet

ENGLISH

Multilayer Ceramic Band Pass Filter, 2.4 GHz ISM Band Working Frequency, RFBPF Series – 1608(0603) RS Stock number 884-2278

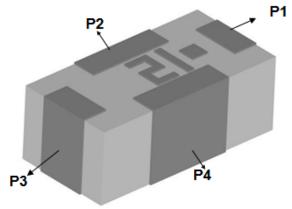
FEATURES

- Miniature footprint: 1.6 X 0.8 X 0.6 mm³
- Low Profile Thickness
- 3. High Rejection Rate at 2.17GHz
- 4. High attenuation on 2nd harmonic suppressed
- LTCC process

APPLICATIONS

- 2.4GHz ISM band RF applications
- Bluetooth, Wi-Fi certifcate compatiable

CONSTRUCTION



| PIN | Connection | | | |
|-------|-------------|--|--|--|
| 1 | Input port | | | |
| 2 | GND | | | |
| 3 | Output port | | | |
| 4 GND | | | | |

Outline of 2.4GHz Band Pass Filter 0603 (1608) size

DIMENSIONS

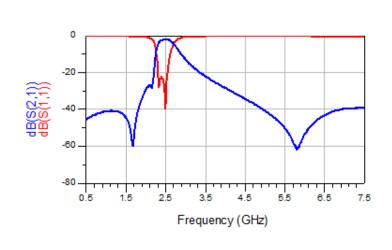
| Figure | Symbol | Dimension (mm) |
|----------|--------|----------------|
| └ | L | 1.60 ± 0.15 |
| | w | 0.80 ± 0.15 |
| w | Т | 0.60 ± 0.10 |
| D T E | Α | 0.45 ± 0.15 |
| | В | 0.70 ± 0.15 |
| | С | 0.20 ± 0.15 |
| | D | 0.20 ± 0.15 |
| | E | 0.25 ± 0.15 |
| | F | 0.30 ± 0.15 |



ELECTRICAL CHARACTERISTICS

| RFBPF1608060AM1T59 | Specification |
|-----------------------------|--|
| Frequencyrange | 2450± 50 MHz |
| InsertionLoss | 3.0 dB max |
| VSWR | 2.0 max |
| Impedance | 50 Ω |
| Attenuation (min.) | 38 dB @ 900~1800 MHz 25 dB @ 1910~2170 MHz 35 dB @ 4800~4900 MHz |
| Operation Temperature Range | -40°C ~ +85°C |

Typical Electrical Chart



SOLDER LAND PATTERN

| Figure | Symbol | Dimension (mm) |
|-----------|--------|----------------|
| <u>L1</u> | L1 | 1.40 ± 0.10 |
| | L2 | 0.80 ± 0.05 |
| | L3 | 0.50 ± 0.05 |
| | L4 | 0.64 ± 0.05 |
| | L5 | 0.37 ± 0.05 |
| | W1 | 0.94 ± 0.10 |
| | W2 | 0.70 ± 0.05 |
| | W3 | 0.43 ± 0.05 |
| | D1 | 0.30 ± 0.05 |
| | D2 | 0.35 ± 0.05 |
| | S1 | 0.35 ± 0.05 |

Line width to de designed to match 50 Ω characteristic impedance, depending on PCB material and thickness. D1 and D2 are the grounding through holes.



RELIABILITYTEST

| Test item | Test condition / Test method | Specification |
|--|--|---|
| Solderability JIS C 0050-4.6 JESD22-B102D | *Solder bath temperature: 235±5°C *Immersion time: 2±0.5 sec | At least 95% of a surface of each terminal electrode must be covered by fresh solder. |
| Lasabina | *Solder: Sn3Ag0.5Cu for lead-free | |
| Leaching (Resistance to dissolution of metallization) IEC 60068-2-58 | *Solder bath temperature: 260±5°C *Leaching immersion time: 30±0.5 sec *Solder: SN63A | Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Resistance to soldering heat JIS C 0050-5.4 | *Preheating temperature: 120~150□, 1 minute. *Solder temperature: 270±5°C *Immersion time: 10±1 sec *Solder: Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs | No mechanical damage. Samples shall satisfy electrical specification after test. Loss of metallization on the edges of each electrode shall not exceed 25%. |
| Drop Test JIS C 0044 | *Height: 75 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units: 2 times for each side. | No mechanical damage. Samples shall satisfy electrical specification after test. |
| Adhesive Strength of Termination JIS C 0051- 7.4.3 | *Pressurizing force : 5N(≤ 0603) : 10N(>0603) *Test time : 10±1 sec | No remarkable damage or removal of the termination. |
| Bendingtest JIS C 0051- 7.4.1 | The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours | No mechanical damage. Samples shall satisfy electrical specification after test. |



| Temperature cycle | | 1 |
|---------------------|--|--|
| JIS C 0025 | 30±3 minutes at -40°C±3°C, | No mechanical damage. |
| 013 0 0025 | 10~15 minutes at room temperature, | Samples shall satisfy electrical |
| | 3. 30±3 minutes at +85°C±3°C, | specification after test. |
| | 4. 10~15 minutes at room temperature, | |
| | Total 100 continuous cycles | |
| | Measurement to be made after keeping at | |
| | room temperature for 24±2 hrs | |
| Vibration | *Frequency: 10Hz~55Hz~10Hz(1min) | No mechanical damage. |
| JIS C 0040 | *Total amplitude: 1.5mm | Samples shall satisfy electrical specification |
| | *Test times: 6hrs.(Two hrs each in three | after test. |
| | mutually perpendicular directions) | |
| High temperature | *Temperature: 85°C±2°C | No mechanical damage. |
| JIS C 0021 | *Test duration: 1000+24/-0 hours | Samples shall satisfy electrical specification |
| | Measurement to be made after keeping at | after test. |
| | room temperature for 24±2 hrs | |
| Humidity | *Humidity: 90% to 95% R.H. | No mechanical damage. |
| (steady conditions) | *Temperature: 40±2°C | Samples shall satisfy electrical specification |
| JIS C 0022 | *Time: 1000+24/-0 hrs. | after test. |
| | Measurement to be made after keeping at | |
| | room temperature for 24±2 hrs | |
| | %500hrs measuring the first data then | |
| | 1000hrs data | |
| Low temperature | *Temperature : -40°C±2°C | No mechanical damage. |
| JIS C 0020 | *Test duration: 1000+24/-0 hours | Samples shall satisfy electrical specification |
| | Measurement to be made after keeping at | after test. |
| | room temperature for 24±2 hrs | |
| | | |



SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

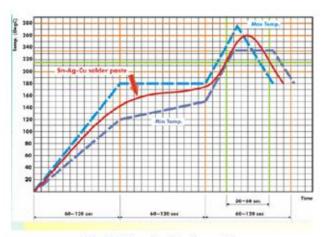


Fig 2, Infrared soldering profile

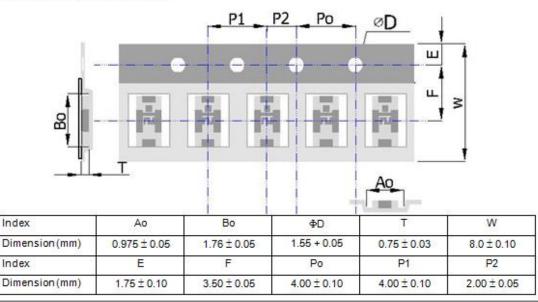
ORDERING CODE

| RF | BPF | 160806 | 0 | A | M1T59 |
|---------------------|--|---|--|--------------------------------|------------------------------|
| Walsin RF device | Product Code BPF: Band Pass Filter | Dimension code Per 2 digits of Length, Width, Thickness: e.g.: 160806= Length 16, Width 08, Thickness06 | Unit of dimension 0:0.1 mm 1:1.0 mm | Application A: 2.4GHZ ISM Band | Specification Design Code |

Minimum Ordering Quantity: 4000 pcs per reel.

PACKAGING

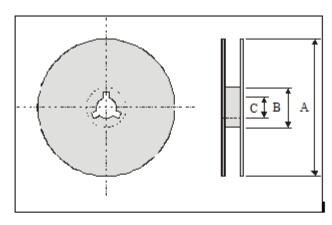
Paper Tape specifications (unit: mm)





Reel dimensions





| Index | Α | В | С |
|----------------|--------|-------|-------|
| Dimension (mm) | Ф178.0 | Ф60.0 | Ф13.0 |

Taping Quantity: 4000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and for reliability requirements to the applications listed in the above.

Storage condition

- Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature : -10 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.